P-Channel 60-V (D-S) 175 °C MOSFET

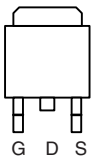
PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)[d]
- 60	0.008 at V_{GS} = - 10 V	- 110
	0.0105 at V_{GS} = - 4.5 V	

FEATURES

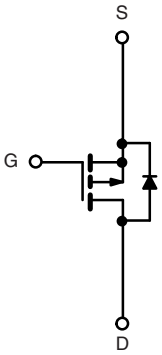
- TrenchFET® Power MOSFET
- Package with Low Thermal Resistance
- 100 % R_g Tested

Pb Available
RoHS* COMPLIANT

TO-263



Top View



P-Channel MOSFET

Ordering Information: SUM110P06-08L
SUM110P06-08L-E3 (Lead (Pb)-free)

ABSOLUTE MAXIMUM RATINGS T_C = 25 °C, unless otherwise noted				
Parameter		**Symbol**	**Limit**	**Unit**
Drain-Source Voltage		V_{DS}	- 60	V
Gate-Source Voltage		V_{GS}	± 20	
Continuous Drain Current[d] (T_J = 175 °C)	T_C = 25 °C	I_D	- 110	A
	T_C = 125 °C		- 75	
Pulsed Drain Current		I_{DM}	- 200	
Avalanche Current	L = 0.1 mH	I_{AS}	- 85	
Single Pulse Avalanche Energy[d]		E_{AS}	211	mJ
Maximum Power Dissipation	T_C = 25 °C	P_D	272[c]	W
	T_A = 25 °C[b]		3.75[b]	
Operating Junction and Storage Temperature Range		T_J, T_{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS				
Parameter		**Symbol**	**Limit**	**Unit**
Junction-to-Ambient	PCB Mount[d]	R_{thJA}	40	°C/W
Junction-to-Case		R_{thJC}	0.55	

Notes:
a. Duty cycle ≤ 1 %.
b. When Mounted on 1" square PCB (FR-4 material).
c. See SOA curve for voltage derating.
d. Limited by Package.

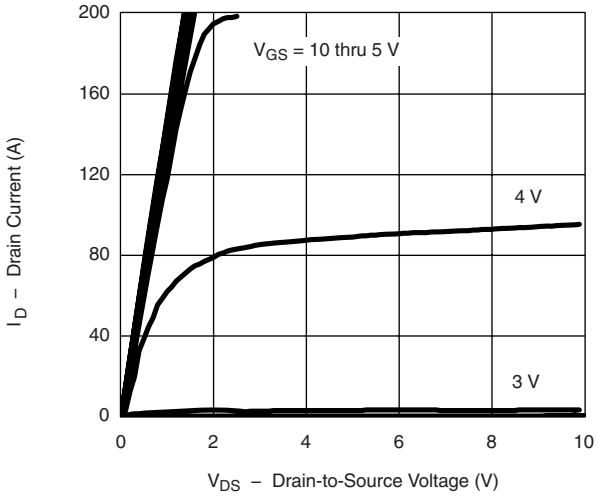
* Pb containing terminations are not RoHS compliant, exemptions may apply.

SPECIFICATIONS T_J = 25 °C, unless otherwise noted						
Parameter	**Symbol**	**Test Conditions**	**Min.**	**Typ.**	**Max.**	**Unit**
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	V_{GS} = 0 V, I_D = - 250 µA	- 60			V
Gate-Threshold Voltage	$V_{GS(th)}$	V_{DS} = V_{GS}, I_D = - 250 µA	- 1		- 3	
Gate-Body Leakage	I_{GSS}	V_{DS} = 0 V, V_{GS} = ± 20 V			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	V_{DS} = - 60 V, V_{GS} = 0 V			- 1	µA
		V_{DS} = - 60 V, V_{GS} = 0 V, T_J = 125 °C			- 50	
		V_{DS} = - 60 V, V_{GS} = 0 V, T_J = 175 °C			- 250	
On-State Drain Current[a]	$I_{D(on)}$	V_{DS} = - 5 V, V_{GS} = - 10 V	- 120			A
Drain-Source On-State Resistance[a]	$r_{DS(on)}$	V_{GS} = - 10 V, I_D = - 30 A		0.0065	0.008	Ω
		V_{GS} = - 10 V, I_D = - 30 A, T_J = 125 °C			0.0129	
		V_{GS} = - 10 V, I_D = - 30 A, T_J = 175 °C			0.016	
		V_{GS} = - 4.5 V, I_D = - 20 A		0.0085	0.0105	
Forward Transconductance[a]	g_{fs}	V_{DS} = - 15 V, I_D = - 50 A	20			S
Dynamic[b]						
Input Capacitance	C_{iss}	V_{GS} = 0 V, V_{DS} = - 25 V, f = 1 MHz		9200		pF
Output Capacitance	C_{oss}			975		
Reverse Transfer Capacitance	C_{rss}			760		
Total Gate Charge[c]	Q_g	V_{DS} = - 30 V, V_{GS} = - 10 V, I_D = - 110 A		160	240	nC
Gate-Source Charge[c]	Q_{gs}			40		
Gate-Drain Charge[c]	Q_{gd}			36		
Gate Resistance	R_g	f = 1 MHz	1.5	3	4.5	Ω
Turn-On Delay Time[c]	$t_{d(on)}$	V_{DD} = - 30 V, R_L = 0.27 Ω $I_D \cong$ - 110 A, V_{GEN} = - 10 V, R_G = 2.5 Ω		20	30	ns
Rise Time[c]	t_r			190	285	
Turn-Off Delay Time[c]	$t_{d(off)}$			140	210	
Fall Time[c]	t_f			300	450	
Source-Drain Diode Ratings and Characteristics T_C = 25 °C[b]						
Continuous Current	I_S				- 110	A
Pulsed Current	I_{SM}				- 200	
Forward Voltage[a]	V_{SD}	I_F = - 50 A, V_{GS} = 0 V		- 1.0	- 1.5	V
Reverse Recovery Time	t_{rr}	I_F = - 50 A, di/dt = 100 A/µs		60	90	ns
Peak Reverse Recovery Charge	$I_{RM(REC)}$			- 3	- 4.5	A
Reverse Recovery Charge	Q_{rr}			0.09	0.2	µC

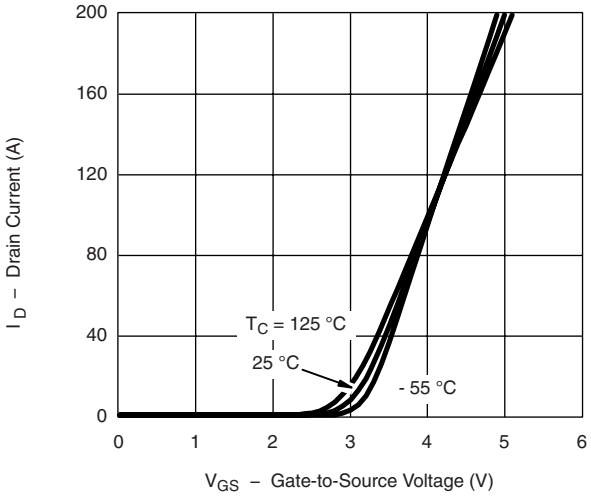
Notes:
a. Pulse test; pulse width ≤ 300 µs, duty cycle ≤ 2 %.
b. Guaranteed by design, not subject to production testing.
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

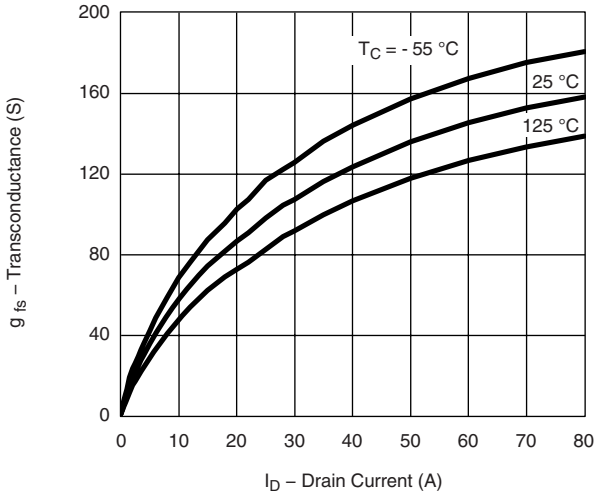
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



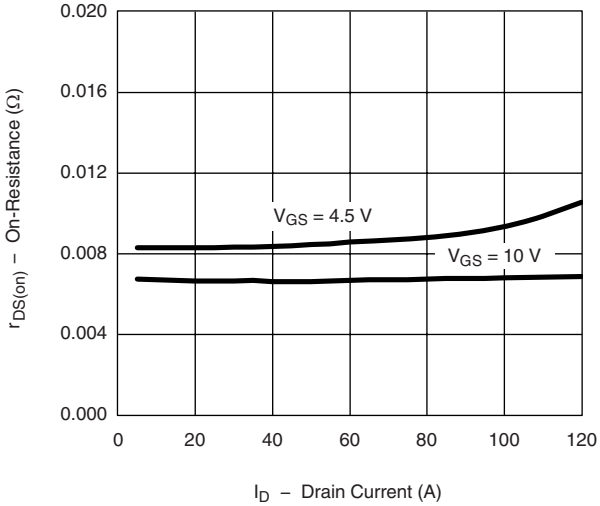
Output Characteristics



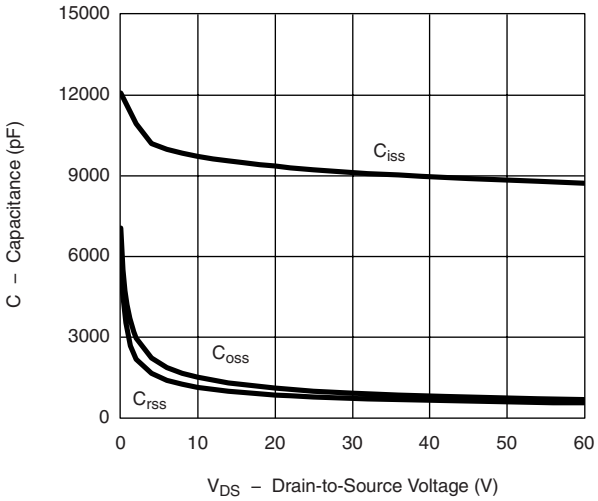
Transfer Characteristics



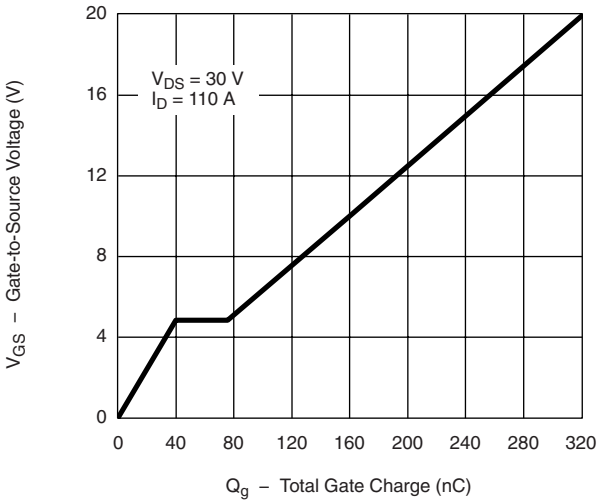
Transconductance



On-Resistance vs. Drain Current

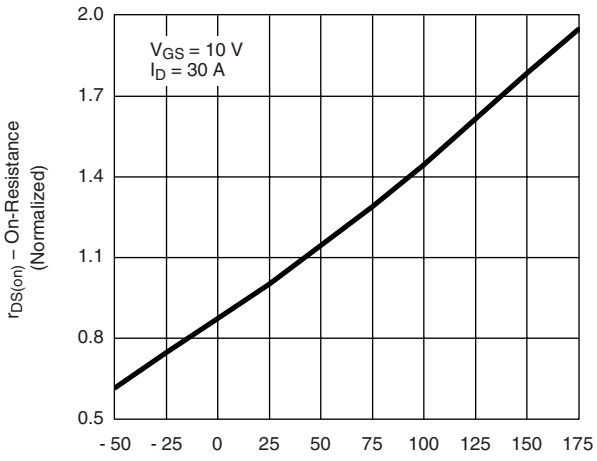


Capacitance

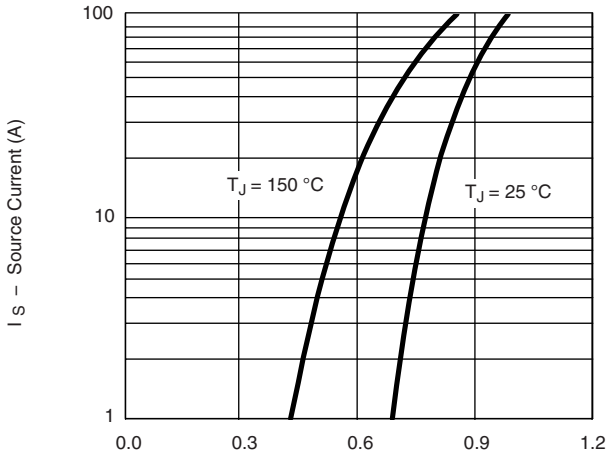


Gate Charge

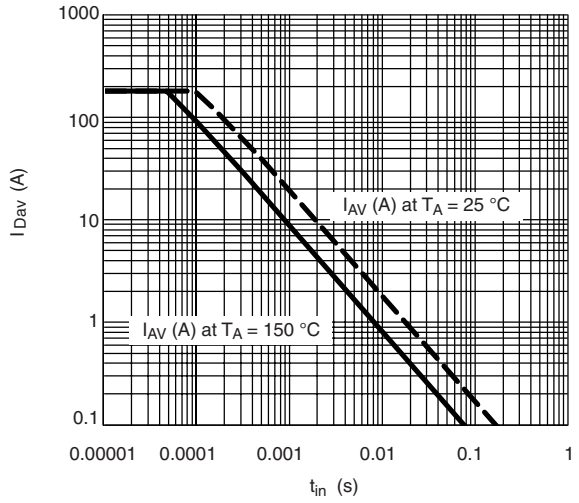
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



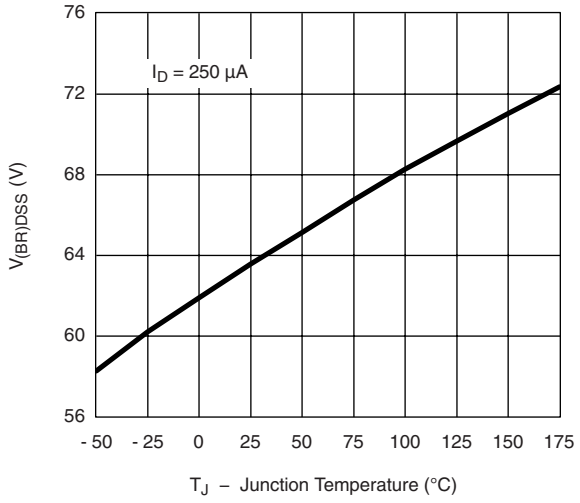
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

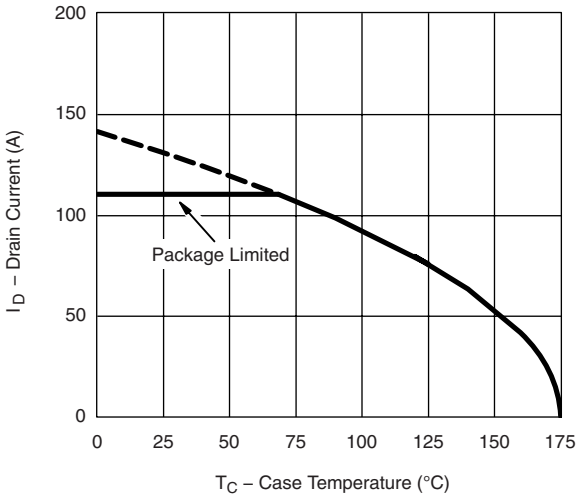


Avalanche Current vs. Time

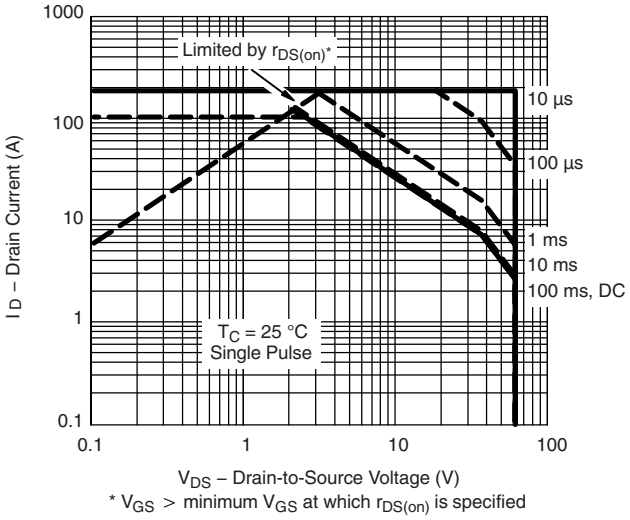


Drain Source Breakdown vs. Junction Temperature

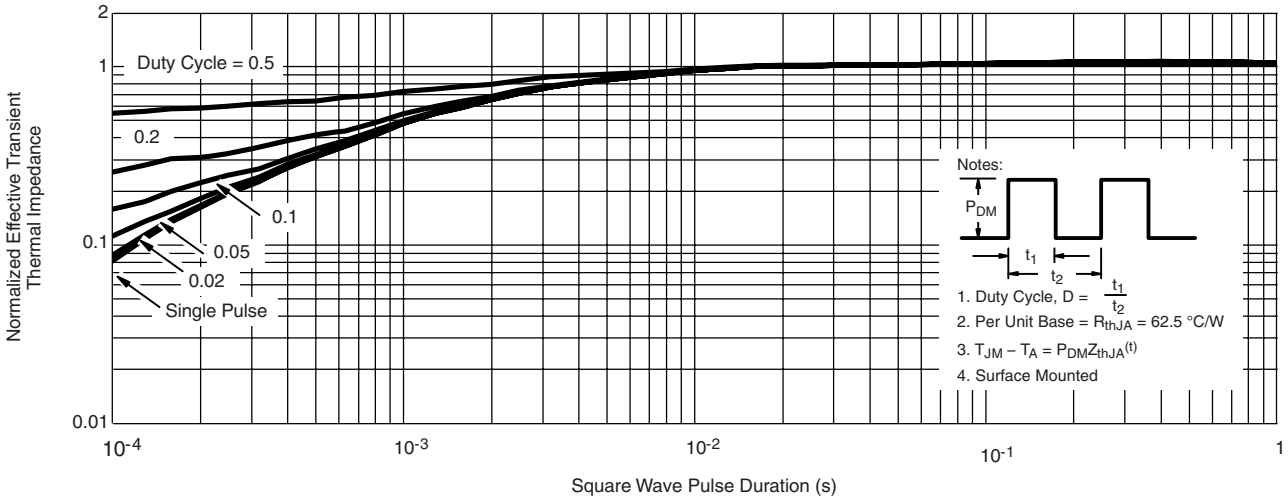
THERMAL RATINGS



Maximum Avalanche and Drain Current vs. Case Temperature



Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case

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